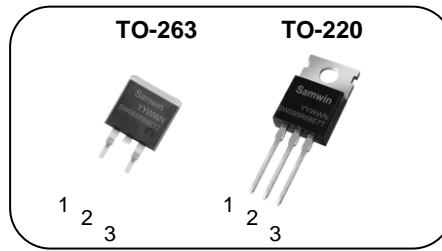


N-channel Enhanced mode TO-263/TO-220 MOSFET

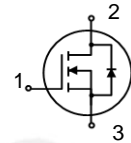
Features

- High ruggedness
- Low $R_{DS(ON)}$ (Typ 9.5m Ω)@ $V_{GS}=10V$
- Low Gate Charge (Typ 47nC)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Application: Synchronous Rectification, Li Battery Protect Board, Inverter



1. Gate 2. Drain 3. Source

BV_{DSS} : 68V
 I_D : 75A
 $R_{DS(ON)}$: 9.5m Ω



General Description

This power MOSFET is produced with advanced technology of SAMWIN. This technology enable the power MOSFET to have better characteristics, including fast switching time, low on resistance, low gate charge and especially excellent avalanche characteristics.



Order Codes

Item	Sales Type	Marking	Package	Packaging
1	SW B 085R68E7T	SW085R68E7T	TO-263	TUBE
2	SW P 085R68E7T	SW085R68E7T	TO-220	TUBE

Absolute maximum ratings

Symbol	Parameter	Value		Unit
		TO-263	TO-220	
V_{DSS}	Drain to source voltage	68		V
I_D	Continuous drain current (@ $T_C=25^\circ C$)	75*		A
	Continuous drain current (@ $T_C=100^\circ C$)	52*		A
I_{DM}	Drain current pulsed (note 1)	300		A
V_{GS}	Gate to source voltage	± 20		V
E_{AS}	Single pulsed avalanche energy (note 2)	180		mJ
E_{AR}	Repetitive avalanche energy (note 1)	18		mJ
dv/dt	Peak diode recovery dv/dt (note 3)	5		V/ns
P_D	Total power dissipation (@ $T_C=25^\circ C$)	125		W
	Derating factor above 25 $^\circ C$	1.0		W/ $^\circ C$
T_{STG}, T_J	Operating junction temperature & storage temperature	-55 ~ + 150		$^\circ C$

*. Drain current is limited by junction temperature.

Thermal characteristics

Symbol	Parameter	Value		Unit
		TO-263	TO-220	
R_{thjc}	Thermal resistance, Junction to case	1.0		$^\circ C/W$
R_{thja}	Thermal resistance, Junction to ambient		51	$^\circ C/W$

Electrical characteristic ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
Off characteristics						
BV_{DSS}	Drain to source breakdown voltage	$V_{GS}=0V, I_D=250\mu A$	68			V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_D=250\mu A$, referenced to 25°C		0.05		$V/^\circ\text{C}$
I_{DSS}	Drain to source leakage current	$V_{DS}=68V, V_{GS}=0V$			1	μA
		$V_{DS}=54V, T_J=125^\circ\text{C}$			50	μA
I_{GSS}	Gate to source leakage current, forward	$V_{GS}=20V, V_{DS}=0V$			100	nA
	Gate to source leakage current, reverse	$V_{GS}=-20V, V_{DS}=0V$			-100	nA
On characteristics						
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(ON)}$	Drain to source on state resistance	$V_{GS}=10V, I_D=40A, T_J=25^\circ\text{C}$		9.5	11.5	$m\Omega$
		$V_{GS}=10V, I_D=40A, T_J=125^\circ\text{C}$		16.4		$m\Omega$
G_{fs}	Forward transconductance	$V_{DS}=5V, I_D=40A$		66		S
Dynamic characteristics						
C_{iss}	Input capacitance	$V_{GS}=0V, V_{DS}=34V, f=1\text{MHz}$		2053		pF
C_{oss}	Output capacitance			164		
C_{rss}	Reverse transfer capacitance			125		
$t_{d(on)}$	Turn on delay time	$V_{DS}=34V, I_D=30A, R_G=4.7\Omega, V_{GS}=10V$ (note 4,5)		14		ns
t_r	Rising time			46		
$t_{d(off)}$	Turn off delay time			34		
t_f	Fall time			15		
Q_g	Total gate charge	$V_{DS}=54V, V_{GS}=10V, I_D=30A, I_G=10\text{mA}$ (note 4,5)		47		nC
Q_{gs}	Gate-source charge			10		
Q_{gd}	Gate-drain charge			20		
R_g	Gate resistance	$V_{DS}=0V$, Scan F mode		3		Ω

Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_S	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			75	A
I_{SM}	Pulsed source current				300	A
V_{SD}	Diode forward voltage drop.	$I_S=45A, V_{GS}=0V$			1.4	V
t_{rr}	Reverse recovery time	$I_S=30A, V_{GS}=0V,$		13		ns
Q_{rr}	Reverse recovery charge	$di/dt=100A/\mu s$		4		nC

※. Notes

1. Repeattive rating : pulse width limited by junction temperature.
2. $L=0.5\text{mH}, I_{AS}=26.8A, V_{DD}=30V, R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$
3. $I_{SD} \leq 30A, di/dt = 100A/\mu s, V_{DD} \leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$
4. Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
5. Essentially independent of operating temperature.

Fig. 1. On-state characteristics

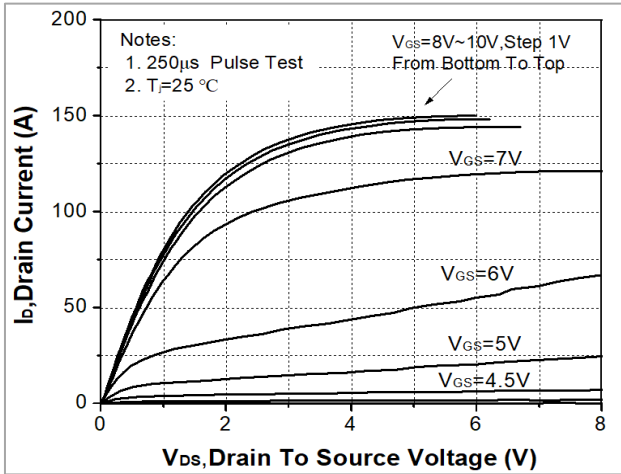


Fig. 2. Transfer Characteristics

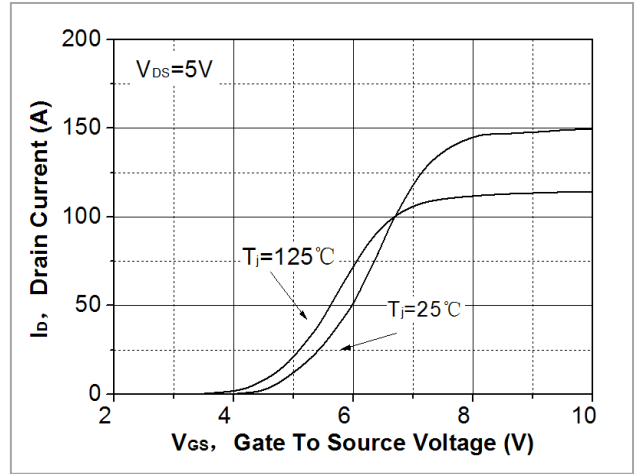


Fig. 3. On-resistance variation vs. drain current and gate voltage

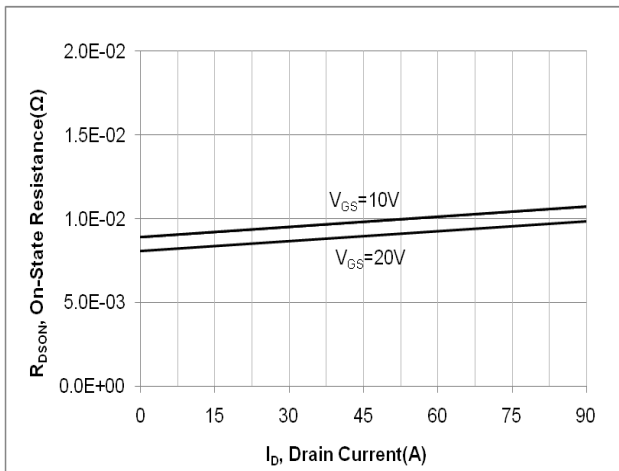


Fig. 4. On-state current vs. diode forward voltage

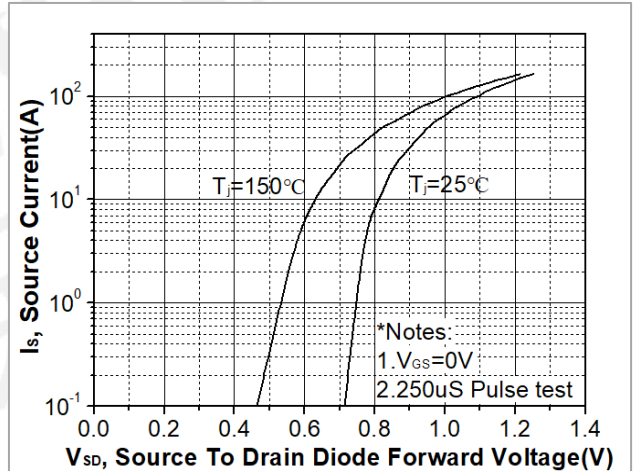


Fig 5. Breakdown voltage variation vs. junction temperature

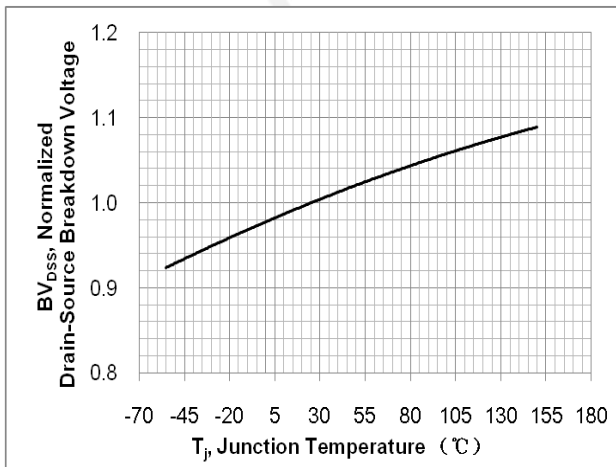


Fig. 6. On-resistance variation vs. junction temperature

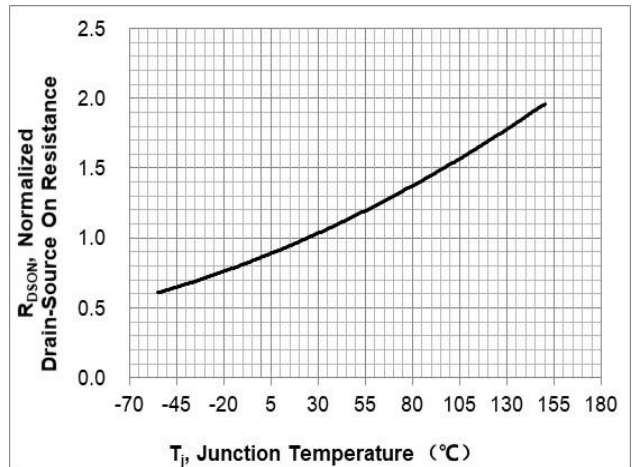


Fig. 7. Gate charge characteristics

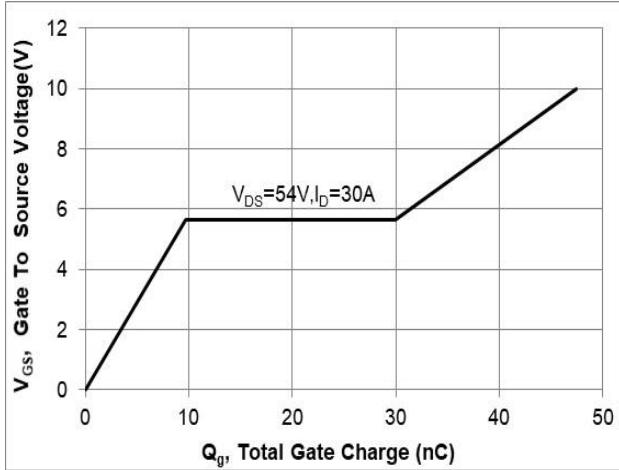


Fig. 8. Capacitance Characteristics

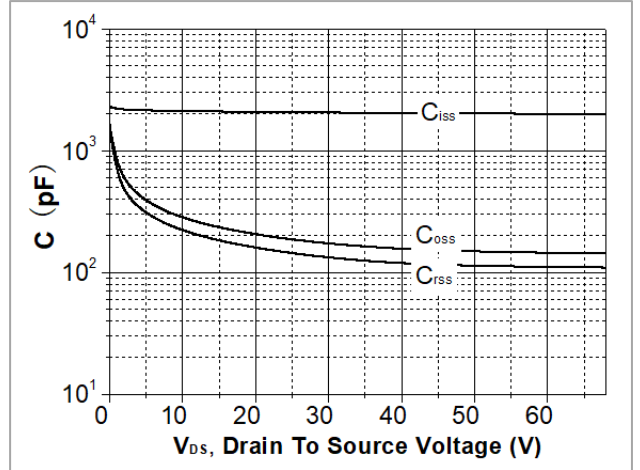


Fig. 9. Maximum safe operating area (TO-263&TO-220)

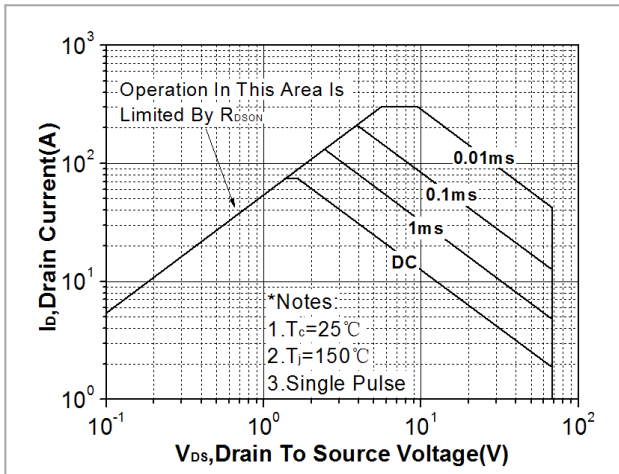


Fig. 10. Maximum drain current vs. case temperature

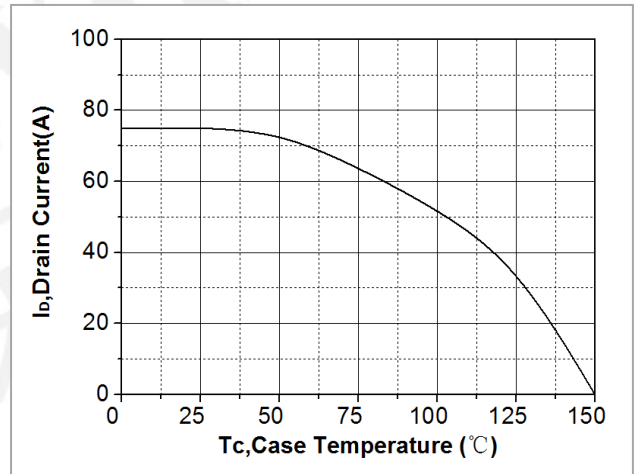


Fig. 11. Transient thermal response curve(TO-263&TO-220)

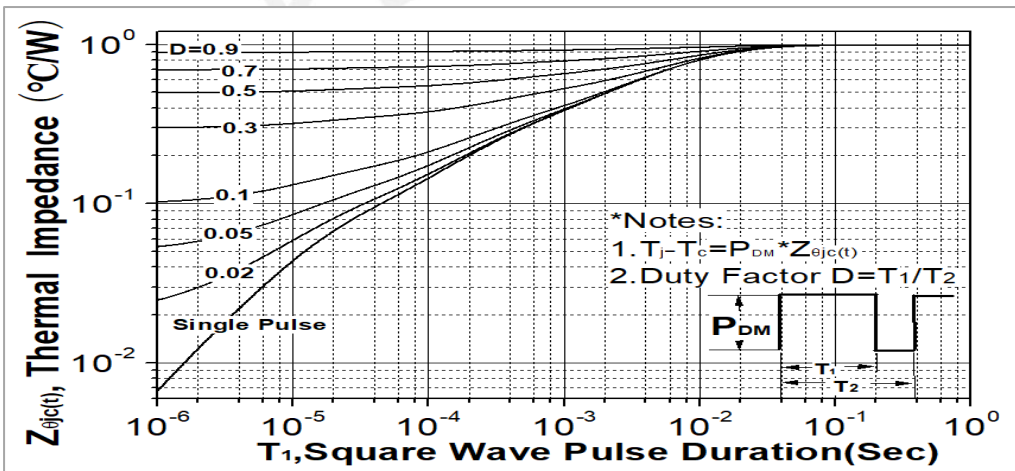


Fig. 12. Gate charge test circuit & waveform

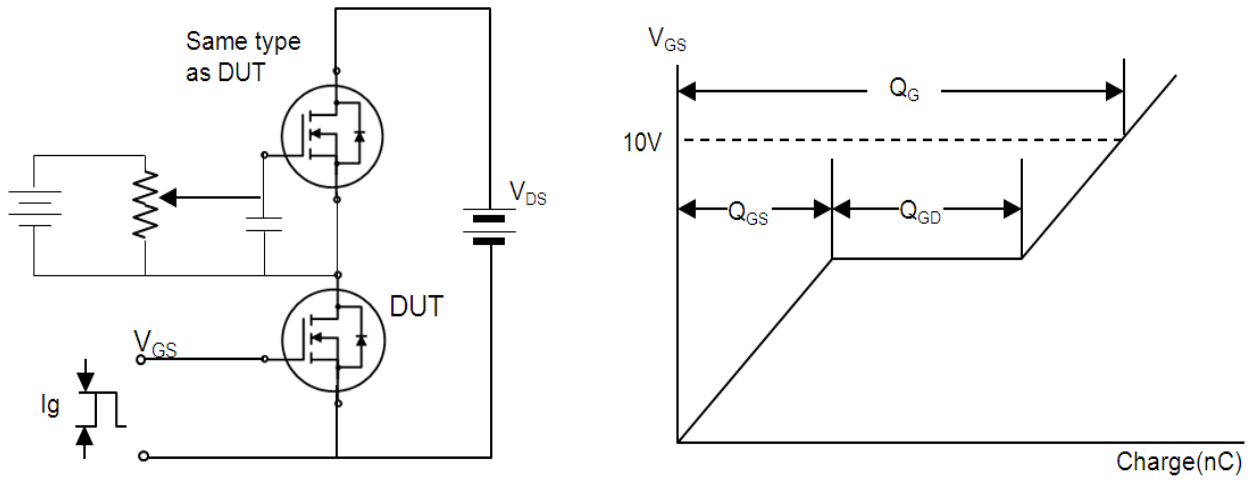


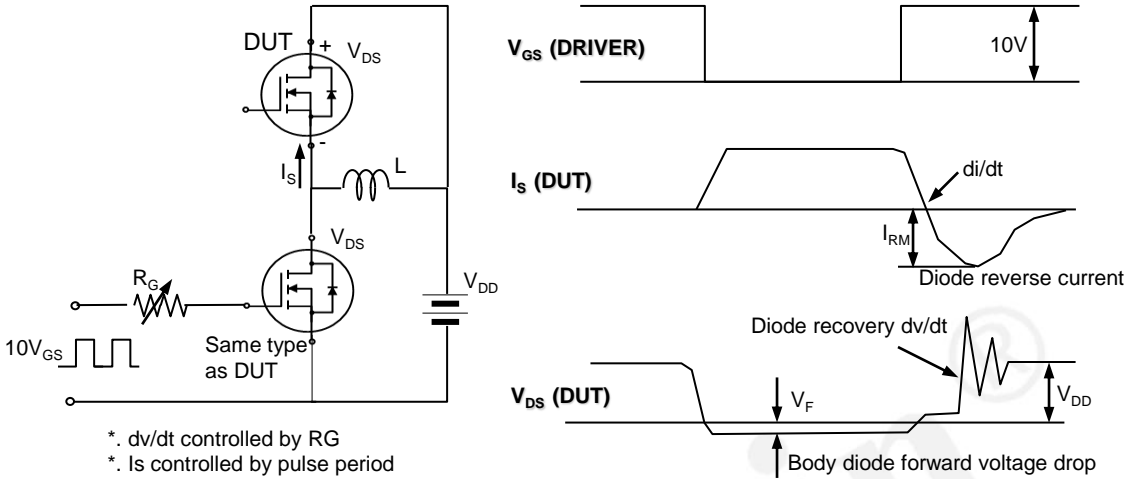
Fig. 13. Switching time test circuit & waveform



Fig. 14. Unclamped Inductive switching test circuit & waveform




Fig. 15. Peak diode recovery dv/dt test circuit & waveform



DISCLAIMER

* All the data & curve in this document was tested in SEMIPOWER TESTING & APPLICATION CENTER.

* This product has passed the PCT,TC,HTRB,HTGB,HAST,PC and Solderdunk reliability testing.

* Qualification standards can also be found on the Web site (<http://www.semipower.com.cn>) 

* Suggestions for improvement are appreciated, Please send your suggestions to samwin@samwinsemi.com

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